BYT 03-200 $\rightarrow 400$
FAST RECOVERY RECTIFIER DIODES

- VERY LOW REVERSE RECOVERY TIME
- VERY LOW SWITCHING LOSSES
- LOW NOISE TURN-OFF SWITCHING


## SUITABLE APPLICATIONS

- FREE WHEELING DIODE IN CONVERTERS AND MOTOR CONTROL CIRCUITS
- RECTIFIER IN S.M.P.S.


ABSOLUTE MAXIMUM RATINGS (limiting values)

| Symbol | Parameter |  | Value | Unit |
| :---: | :--- | :--- | :---: | :---: |
| $\mathrm{I}_{\text {FRM }}$ | Repetive Peak Forward Current | $\mathrm{t}_{\mathrm{p}} \leq 10 \mu \mathrm{~s}$ | 60 | A |
| $\mathrm{I}_{\mathrm{F}(\mathrm{AV})}$ | Average Forward Current* $^{*}$ | $\mathrm{T}_{\mathrm{a}}=65^{\circ} \mathrm{C}$ <br> $\delta=0.5$ | 3 | A |
| $\mathrm{I}_{\text {FSM }}$ | Surge non Repetitive Forward Current | $\mathrm{t}_{\mathrm{p}}=10 \mathrm{~ms}$ <br> $S i n u s o i d a l$ | 60 | A |
| $\mathrm{P}_{\text {tot }}$ | Power Dissipation * | $\mathrm{T}_{\mathrm{a}=65^{\circ} \mathrm{C}}$ | 4.2 | W |
| $\mathrm{T}_{\text {stg }}$ <br> $\mathrm{T}_{\mathrm{j}}$ | Storage and Junction Temperature Range | -40 to +150 <br> -40 to +150 | ${ }^{\circ} \mathrm{C}$ |  |


| Symbol | Parameter | BYT 03- |  |  | Unit |
| :---: | :--- | :---: | :---: | :---: | :---: |
|  |  | $\mathbf{2 0 0}$ | $\mathbf{3 0 0}$ | $\mathbf{4 0 0}$ |  |
| $V_{\text {RRM }}$ |  | 200 | 300 | 400 | V |
| $\mathrm{~V}_{\text {RSM }}$ | Non Repetitive Peak Reverse Voltage | 220 | 330 | 440 | V |

## THERMAL RESISTANCE

| Symbol | Parameter | Value | Unit |
| :---: | :--- | :---: | :---: |
| $\mathrm{R}_{\mathrm{th}(\mathrm{j}-\mathrm{a})}$ | Junction-ambient $^{*}$ | 20 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

* On infinite heatsink with 10 mm lead length.

BYT 03-200 $\rightarrow 400$

## ELECTRICAL CHARACTERISTICS

STATIC CHARACTERISTICS

| Synbol | Test Conditions |  | Min. | Typ. | Max. | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{I}_{\mathrm{R}}$ | $\mathrm{T}_{\mathrm{j}}=25^{\circ} \mathrm{C}$ | $\mathrm{V}_{\mathrm{R}}=\mathrm{V}_{\mathrm{RRM}}$ |  |  | 20 | $\mu \mathrm{A}$ |
|  | $\mathrm{T}_{\mathrm{j}}=100^{\circ} \mathrm{C}$ |  |  |  | 0.5 | mA |
| $V_{F}$ | $\mathrm{T}_{\mathrm{j}}=25^{\circ} \mathrm{C}$ | $\mathrm{I}_{\mathrm{F}}=3 \mathrm{~A}$ |  |  | 1.5 | V |
|  | $\mathrm{T}_{\mathrm{j}}=100^{\circ} \mathrm{C}$ |  |  |  | 1.4 |  |

RECOVERY CHARACTERISTICS

| Symbol | Test Conditions |  |  | Min. | Typ. | Max. | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{t}_{\mathrm{rr}}$ | $\mathrm{T}_{\mathrm{j}}=25^{\circ} \mathrm{C}$ | $\mathrm{I}_{\mathrm{F}}=1 \mathrm{~A}$ | $\mathrm{diF} / \mathrm{dt}=-15 \mathrm{~A} / \mu \mathrm{s}$ | $\mathrm{V}_{\mathrm{R}}=30 \mathrm{~V}$ |  |  | 55 |
|  |  | $\mathrm{I}_{\mathrm{F}}=0.5 \mathrm{~A}$ | $\mathrm{I}_{\mathrm{R}}=1 \mathrm{~A}$ | $\mathrm{t}_{\mathrm{rr}}=0.25 \mathrm{~A}$ |  |  | 25 |

TURN-OFF SWITCHING CHARACTERISTICS - Without Series Inductance

| Symbol | Test Conditions |  |  |  | Min. | Typ. | Max. | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{t}_{\text {IRM }}$ | $\mathrm{diF} / \mathrm{dt}=-50 \mathrm{~A} / \mu \mathrm{s}$ | $\begin{aligned} & \mathrm{T}_{\mathrm{j}}=100^{\circ} \mathrm{C} \\ & \mathrm{~L}_{\mathrm{P}} \leq 0.05 \mu \mathrm{H} \end{aligned}$ | $V_{C C}=200 \mathrm{~V}$ | $I_{F}=3 \mathrm{~A}$ |  | 35 | 50 | ns |
| IRM | $\mathrm{diF} / \mathrm{dt}=-50 \mathrm{~A} / \mu \mathrm{s}$ |  |  |  |  | 1.5 | 2 | A |

To evaluate the conduction losses use the following equations:

$$
\left.V_{F}=1.1+0.050 \mathrm{IF}_{F} \quad \mathrm{P}=1.1 \times \mathrm{IF}_{\mathrm{F}} \mathrm{AV}\right)+0.050 \mathrm{IF}^{2}(\mathrm{RMS})
$$

Figure 1. Maximum average power dissipation versus average forward current.


Figure 3. Thermal resistance versus lead length.


Figure 4. Transient thermal impedance junction-ambient for mounting $\mathrm{n}^{\circ} 2$ versus pulse duration ( $\mathrm{L}=10 \mathrm{~mm}$ ).


Figure 2. Average forward current versus ambient temperature.


Mounting $\mathrm{n}^{\circ} 1$
Mounting $\mathrm{n}^{\circ}$ 2 INFINITE HEATSINK PRINTED CIRCUIT



Figure 5. Peak forward current versus peak forward voltage drop (maximum values).


Figure 7. Recovery time versus dif/dt.


Figure 9. Peak forward voltage versus $\mathrm{di}_{\mathrm{F}} / \mathrm{dt}$.


Figure 11. Dynamic parameters versus junction temperature.


Figure 8. Peak forward voltage versus $\mathrm{di}_{\mathrm{F}} / \mathrm{dt}$.


Figure 10. Recovery charge versus $\mathrm{di}_{\mathrm{F}} / \mathrm{dt}$ (typical values).


Figure 12. Non repetitive surge peak current versus number of cycles.


## PACKAGE MECHANICAL DATA

## DO 27A (Plastic)



| REF. | DIMENSIONS |  |  |  | NOTES |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | Millimeters |  | Inches |  |  |
|  | Min. | Max. | Min. | Max. |  |
| A |  | 9.80 |  | 0.385 | 1 - The lead diameter $\varnothing D$ is not controlled over zone $E$ <br> 2 - The minimum axial lengh within which the device may be placed with its leads bent at right angles is 0.59 " $(15 \mathrm{~mm})$ |
| B | 26 |  | 1.024 |  |  |
| $\varnothing$ C |  | 5.10 |  | 0.200 |  |
| $\varnothing \mathrm{D}$ |  | 1.28 |  | 0.050 |  |
| E |  | 1.25 |  | 0.049 |  |

Cooling method: by convection (method A)
Marking: type number; white band indicates cathode Weight: 1g

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